

Reply to office action dated 2/10/04

AMENDMENTS TO THE SPECIFICATION

Please replace paragraph number [0001] with the following amended paragraph:

[0001] This patent application is a continuation claiming priority from a  
5 patent application having serial number 10/210,727 titled "Slotted Substrate and  
Method of Making" filed 7/31/2002, and issued as patent number [[\_\_\_\_]]  
US 6,666,546 B1.